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Vishay Siliconix

# Automotive P-Channel 80 V (D-S) 175 °C MOSFET

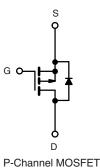


PRODUCT SUMMARY			
V <sub>DS</sub> (V)	-80		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0195		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0290		
I <sub>D</sub> (A) <sup>g</sup>	-62		
Configuration	Single		

#### **FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % Rq and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ORDERING INFORMATION		
	Package	PowerPAK® SO-8L
	Lead (Pb)-free and halogen-free	SQJ185ELP (for detailed order number please see <a href="https://www.vishay.com/doc?79771">www.vishay.com/doc?79771</a> )

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage  Gate-source voltage a		V <sub>DS</sub>	-80	V		
		$V_{GS}$	± 20	7 v		
Continuous drain current <sup>g</sup>	T <sub>C</sub> = 25 °C b	I <sub>D</sub>	-62			
	T <sub>C</sub> = 125 °C		-35			
Continuous source current (diode conduction) b, g		I <sub>S</sub>	90	Α		
Pulsed drain current c, g	ed drain current c, g		-145			
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	41			
Single pulse avalanche energy	L = 0.1 IIII	E <sub>AS</sub>	84	mJ		
Maximum power dissipation c, g	T <sub>C</sub> = 25 °C	P <sub>D</sub>	145	W		
	T <sub>C</sub> = 125 °C	rD	48	VV		
Operating junction and storage temperature r	range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
Soldering recommendations (peak temperatu	ıre) <sup>d, e</sup>		260	C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount e	$R_{thJA}$	42	°C/W	
Junction-to-case (drain) <sup>f</sup>		$R_{thJC}$	1.03	C/VV	

- a. Not intended for continuous use with positive gate voltage > 5.0 V
- Package limited
- When mounted on 1" square PCB (FR4 material)
- See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 % As per on JESD51-14

- Values based on RthJC and TC of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	1					L		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0, I <sub>D</sub> = -250 μA		-80	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-2.0	-2.5		
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = -80 V	-	-	-1		
Zero gate voltage drain current	I <sub>DSS</sub>		V <sub>DS</sub> = -80 V, T <sub>J</sub> = 125 °C	-	-	-50	μΑ	
		$V_{GS} = 0 V$	V <sub>DS</sub> = -80 V, T <sub>J</sub> = 175 °C	-	-	-150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -10 V	$V_{DS} \ge -5 \text{ V}$	-30	-	-	Α	
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A	-	0.0165	0.0195	Ω	
Duning any superior and attacks are a		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 125 °C	-	-	0.0315		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 175 °C	-	-	0.0380		
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -8 A	-	0.0240	0.0290		
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> =	-15 V, I <sub>D</sub> = -10 A	-	32	-	S	
Dynamic <sup>b</sup>								
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = -25 V, f = 1 MHz	-	3510	4914	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	1387	1942		
Reverse transfer capacitance	C <sub>rss</sub>			-	66	93		
Total gate charge <sup>c</sup>	Qg			-	46	69		
Gate-source charge c	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V	$V_{GS} = -10 \text{ V}$ $V_{DS} = -40 \text{ V}, I_D = -15 \text{ A}$		12	-	nC	
Gate-drain charge <sup>c</sup>	$Q_{gd}$				6	-		
Gate resistance	R <sub>g</sub>		f = 1 MHz		1.5	2.3	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>		$V_{DD} = -40 \text{ V}, R_{I} = 2.66 \Omega,$		17	26	- ns	
Rise time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> =			5	9		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong -15$ A, $V_{GEN} = -10$ V, $R_g = 1$ $\Omega$		-	34	51		
Fall time <sup>c</sup>	t <sub>f</sub>			-	5	9		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>							
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-224	Α	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V		-	-0.76	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>			-	42	84	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1 10	10.4 (1/4) 100.4 (		51	102	nC	
Reverse recovery fall time	ta	I <sub>F</sub> = -10 A, di/dt = 100 A/μs		-	21	-	ns	
Reverse recovery rise time	t <sub>b</sub>		1		22	-		
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-2.3	-	Α	

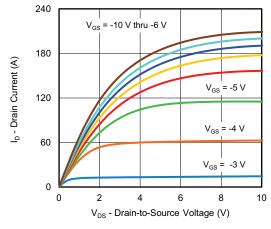
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

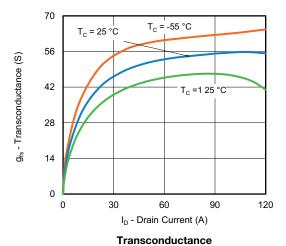
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

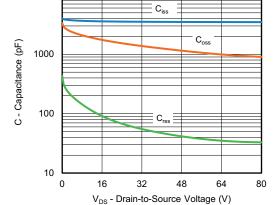


# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

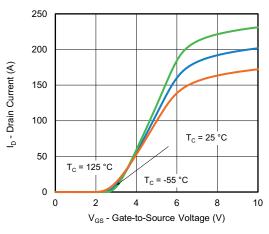


### **Output Characteristics**

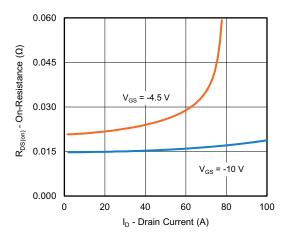




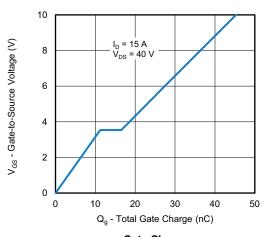
Capacitance



**Transfer Characteristics** 



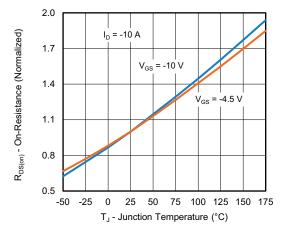
**On-Resistance vs. Drain Current** 



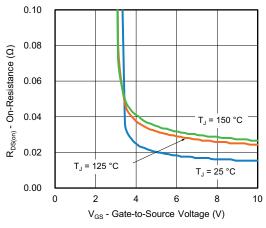
10 000



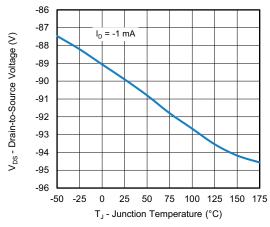
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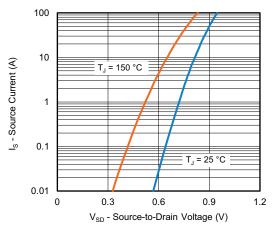
On-Resistance vs. Junction Temperature



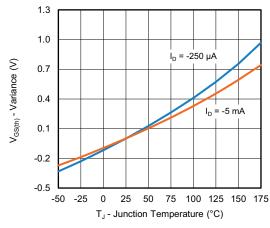
On-Resistance vs. Gate-to-Source Voltage



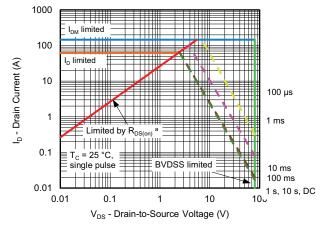
**Drain-Source Breakdown vs. Junction Temperature** 



**Source Drain Diode Forward Voltage** 



**Threshold Voltage** 



Safe Operating Area

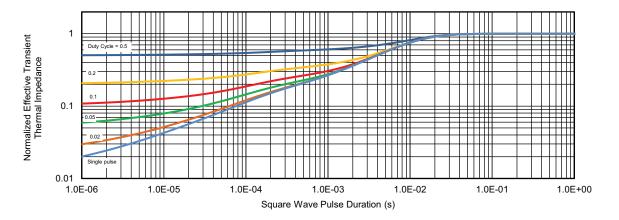
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

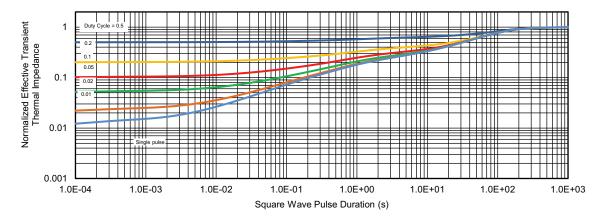
For technical questions, contact: automostechsu



### **THERMAL RATINGS** (T<sub>C</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Case



#### Normalized Thermal Transient Impedance, Junction-to-Ambient

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?62115">www.vishay.com/ppg?62115</a>.



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